



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Ronald Pasqualini

Attorney Docket No.: NSC1P218/P05063

Application No.: 10/053,489

Examiner: Phat X. Cao

Filed: November 2, 2001

Group: 2814

**Title: INTEGRATED CIRCUIT PACKAGE  
WITH LOW INDUCTANCE GROUND PATH  
AND IMPROVED THERMAL CAPABILITY**

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on September 2, 2003 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed

James Spence

**AMENDMENT B (AFTER FINAL)**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated August 15, 2003, please amend the above-identified patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which being on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.

TECHN. 112  
2801  
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